



Symmetry Breaking in the Drain Current of Multi-Finger Transistors

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Outline

- **Review: Drain Current Symmetry in Multi-finger FET Models**
- **Drain Current Symmetry Breaking**
 - Due to wire resistance
 - Due to contact resistance
 - Due to diffusion resistance
 - Due to self heating effect
 - Due to uncorrelated variations among fingers
- **Summary**

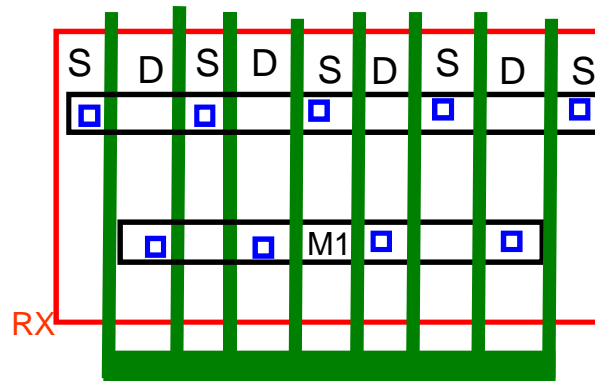
Drain Current Symmetry in Multi-finger FET Models

Multi-finger FETs are often used: Big drivers in standard cells, RF FETs.

Drain current in each finger channel has been treated to be highly symmetric:
Each finger channel has a same drain current.

Multi-finger
FET

$(N_f = 8)$

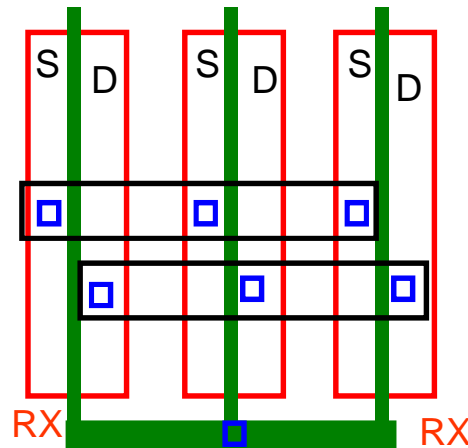


$$I_d(N_f) = N_f i_d$$

in compact models

Multiple diffusion
regions

$par = 3, N_f = 1$
 $\rightarrow m = 3$



In SPICE simulations,
multiplicity m can be provided.
SPICE simulator returns a drain
current that is m times of single
FET's drain current

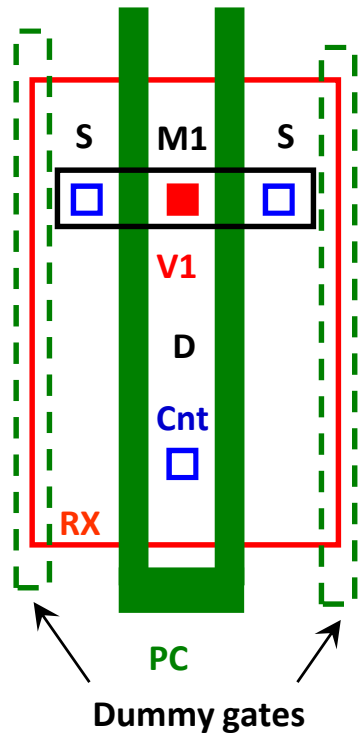
$$I_d(m) = m i_d$$

In general, $m = par \cdot N_f$

Outline

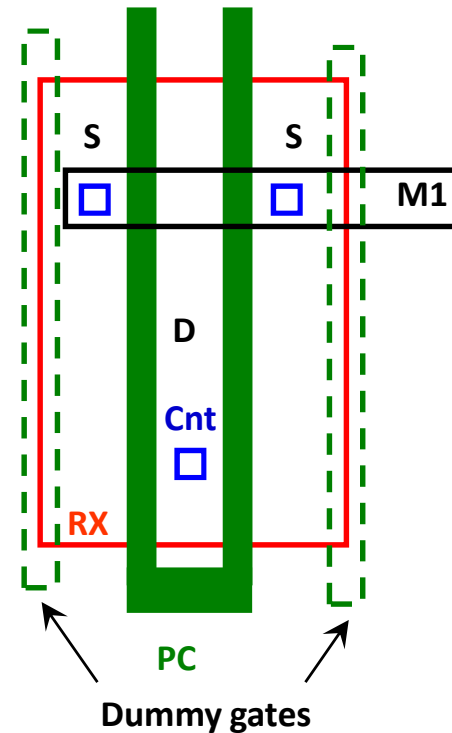
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Symmetry Breaking Due to Wire Resistance



A symmetric layout:

→ Identical drain current in the left finger channel and in the right finger channel.



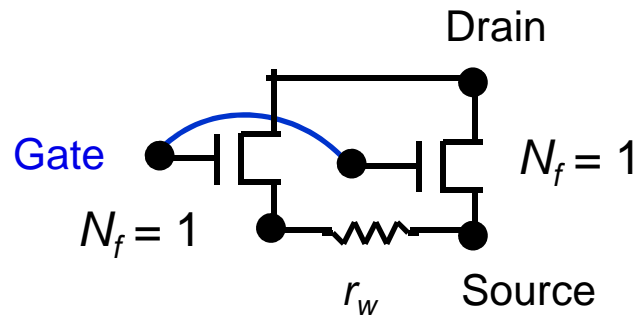
Layout is not fully symmetric:

→ More wire resistance in the left-finger channel

→ Slightly less drain current in the left finger ← **Symmetry is broken**

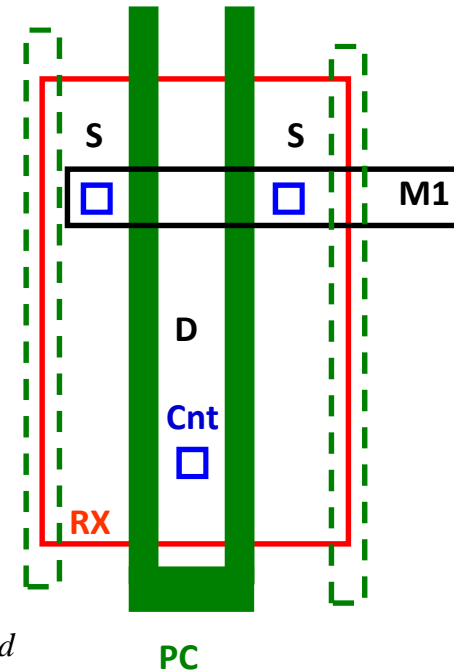
A Two-Finger Transistor and Its SPICE Netlists

A detailed netlist:

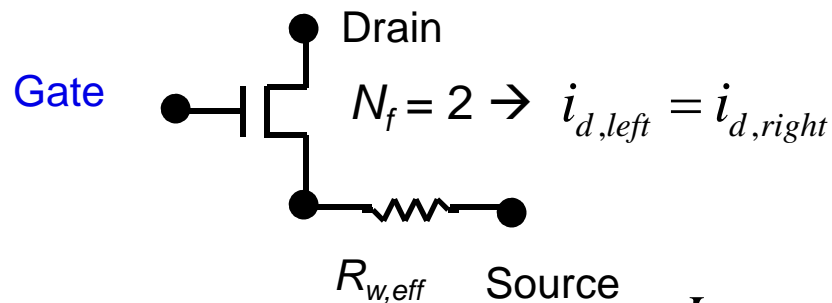


$$i_{d,left} < i_{d,right} = i_d$$

Per-finger average current: $\frac{I_{d,tot}}{2} = \frac{i_{d,left} + i_{d,right}}{2} < i_d$



A reduced netlist for faster simulation:



Per-finger average current: $\frac{I_{d,tot}}{2} < i_d$

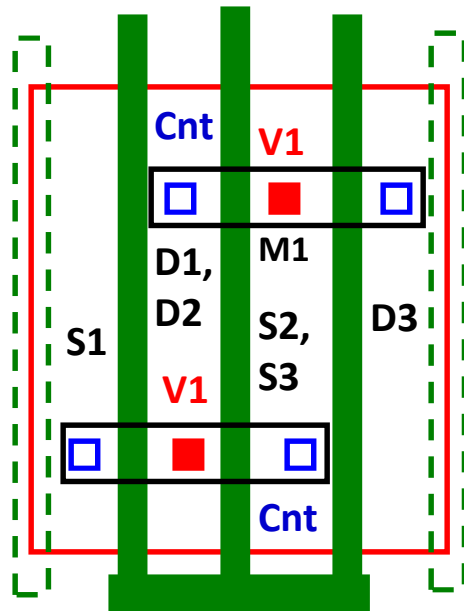
Approximation: Each finger channel carries a same amount of drain current

$$R_{w,eff} = \left(\frac{1}{2}\right)^2 r_w = \frac{1}{4} r_w$$

Outline

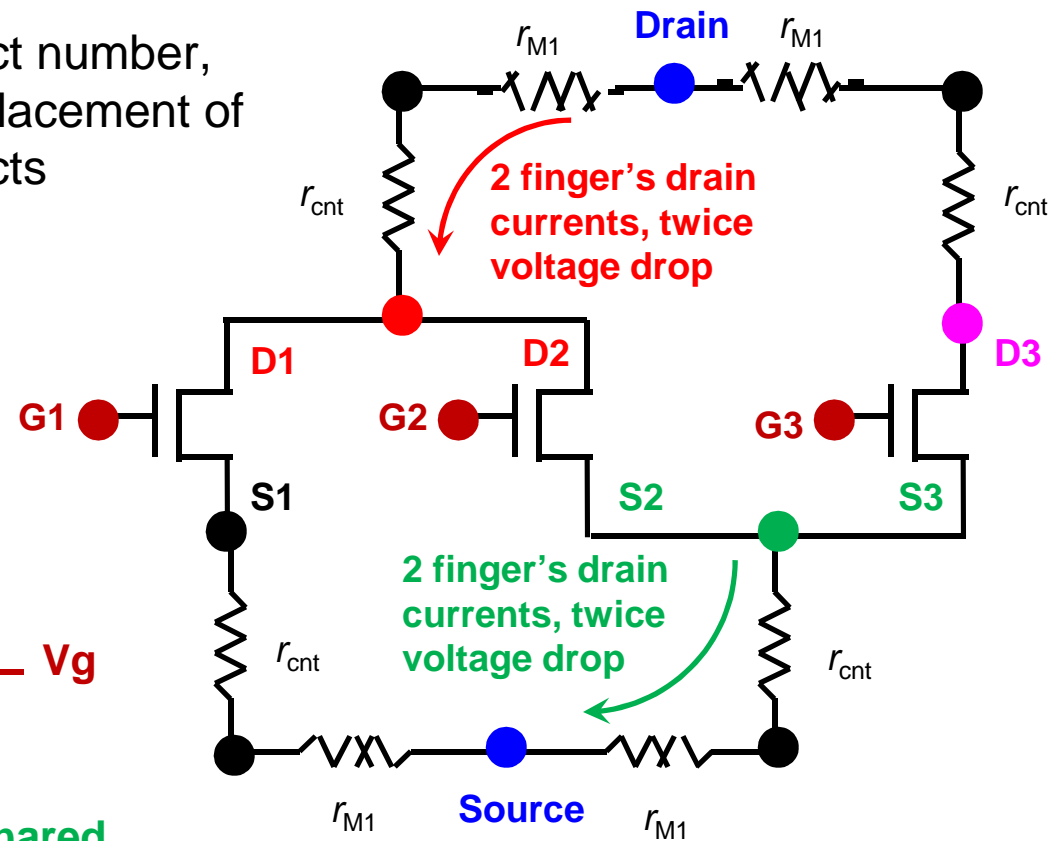
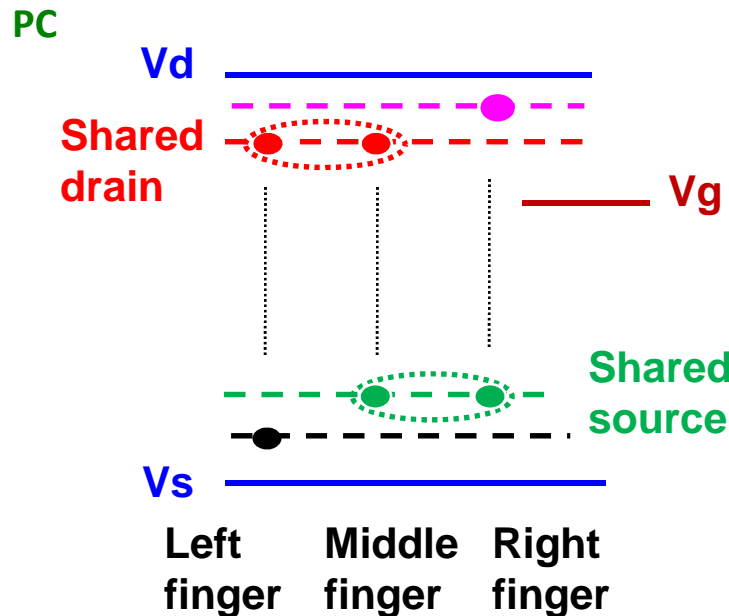
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Symmetry Breaking Due to Contact Resistance (1)



Same source-side R_w ,
same drain-side R_w .

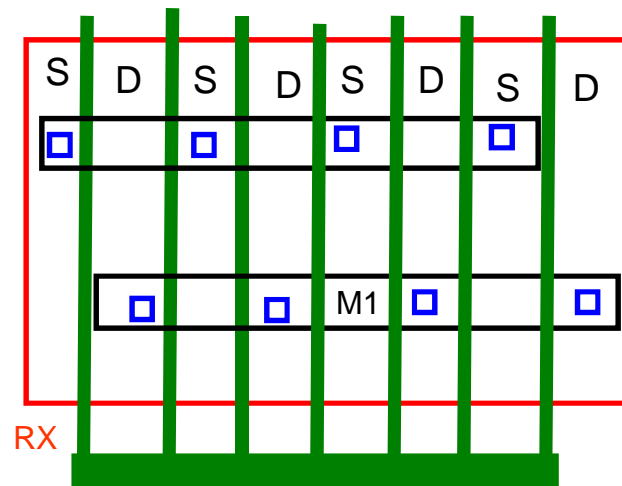
same contact number,
symmetric placement of
those contacts



Ignored diffusion R
in the above netlist

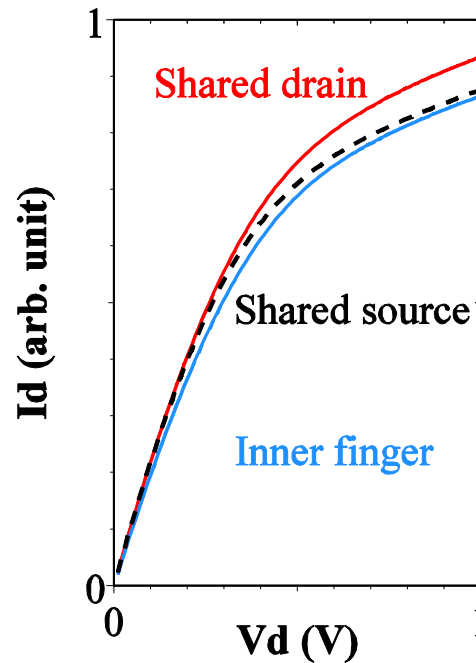
Symmetry Breaking Due to Contact Resistance (2)

Effect of contact R alone
on drain current

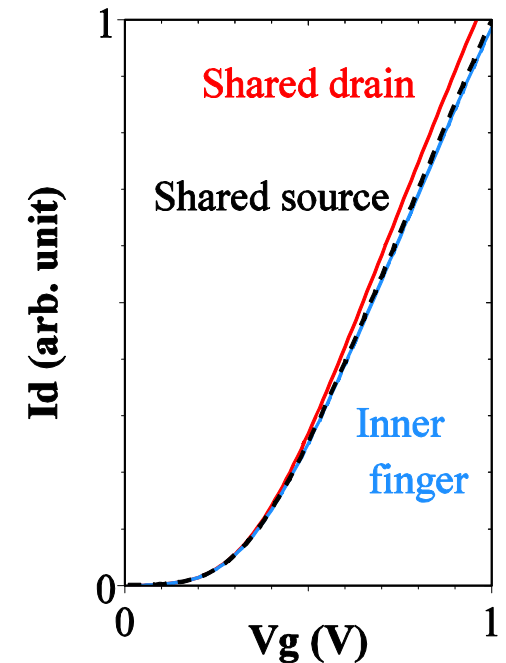


Multi-finger FET

$$N_f = 7$$



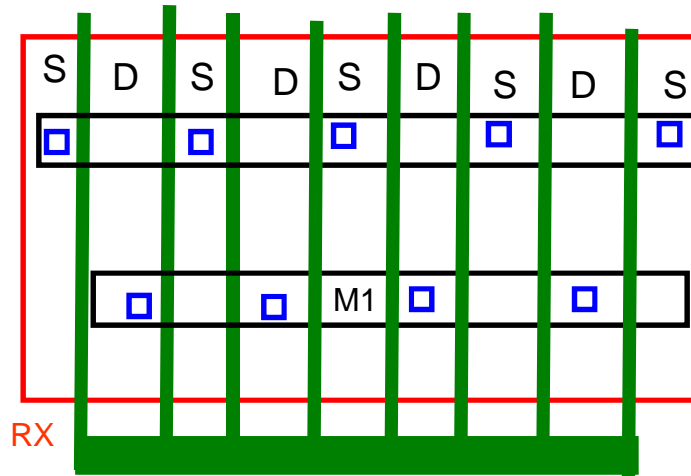
$$V_g = V_{dd} = 0.9 \text{ V}$$



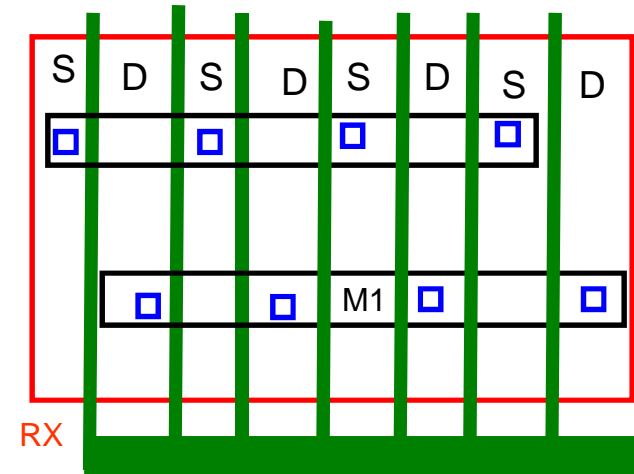
$$V_d = V_{dd}$$

Symmetry is broken

Effective Source/Drain Contact Resistance (1)

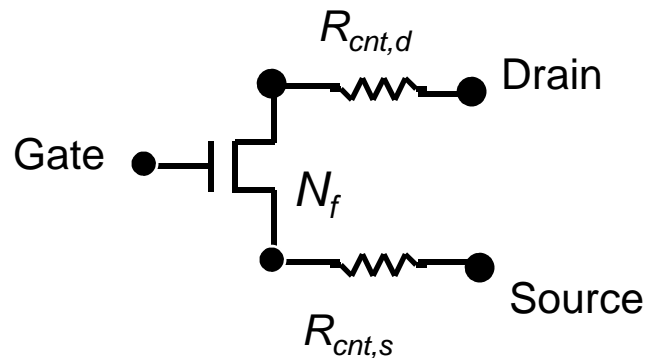


Even N_f



Odd N_f

To reduce simulation time, we still want to use a single FET instance plus a source-side effective $R_{cnt,s}$ element and a drain-side effective $R_{cnt,d}$ element.



$$R_{cnt,s}(\text{old}) = \frac{r_{cnt}}{n_s}, \quad R_{cnt,d}(\text{old}) = \frac{r_{cnt}}{n_d}$$

r_{cnt} – Contact R in a single diffusion region;

n_s – Number of source; n_d – Number of drain

Effective Source/Drain Contact Resistance (2)

Old effective contact R formula assumes a same amount of drain current passing through each **contact**, which is not true.

Approximation: The drain current passing through each **finger channel** is the same.

$$R_{cnt,s/d} = \sum_{k=1}^{n_{s/d}} \left(\frac{I_{cnt,k}}{I_{tot}} \right)^2 r_{cnt}$$

$$\frac{I_{cnt,k}}{I_{tot}} = \frac{1}{N_f}$$

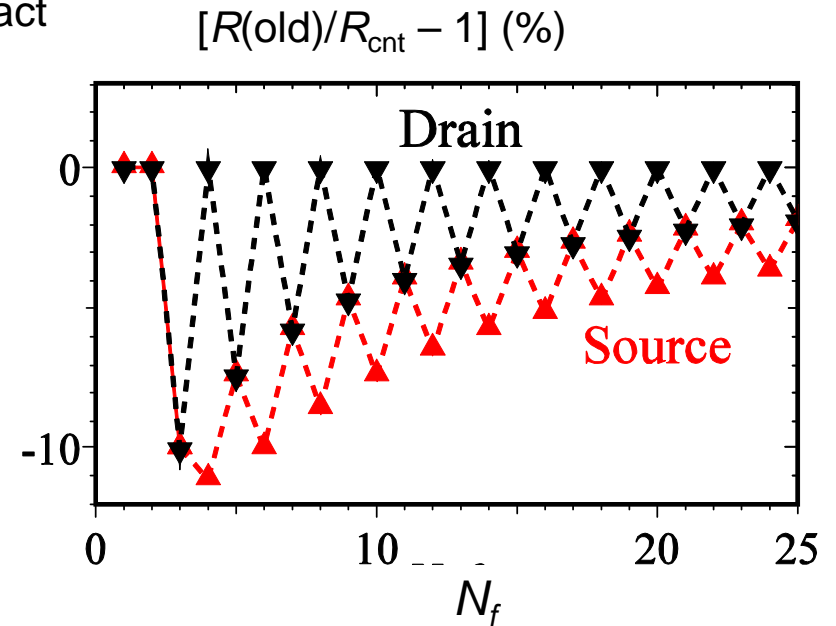
Outer contact

$$\frac{I_{cnt,k}}{I_{tot}} = \frac{2}{N_f}$$

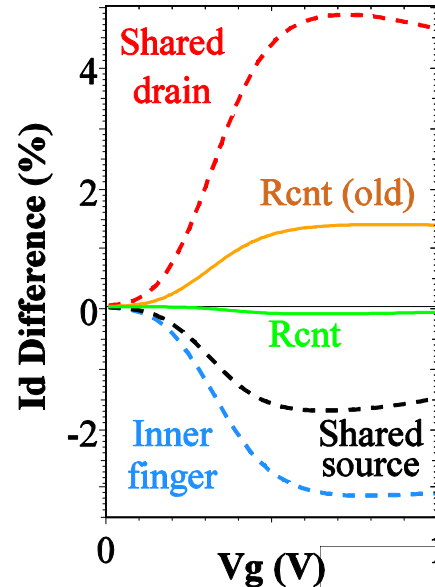
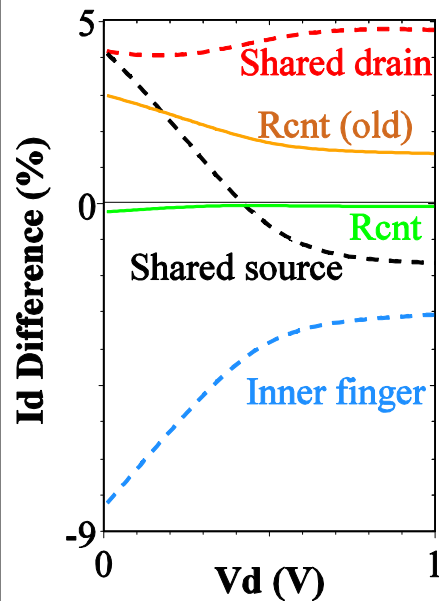
Inner contact

$$R_{cnt,s} = R_{cnt,d} = \frac{2N_f - 1}{N_f^2} r_{cnt}, \quad \text{odd } N_f$$

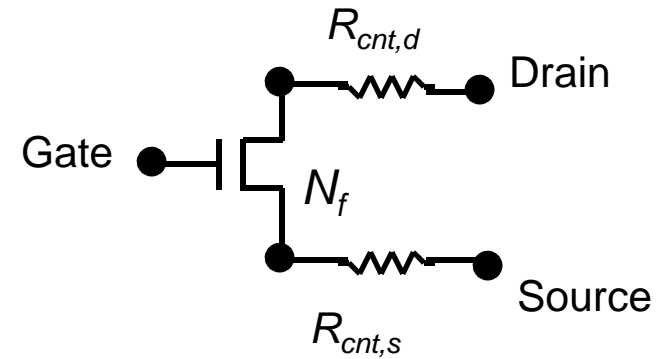
$$R_{cnt,s} = \frac{2N_f - 2}{N_f^2} r_{cnt}, \quad R_{cnt,d} = \frac{2}{N_f} r_{cnt}, \quad \text{even } N_f$$



Accuracy of Effective S/D Contact Resistance



$V_d = V_{dd}$

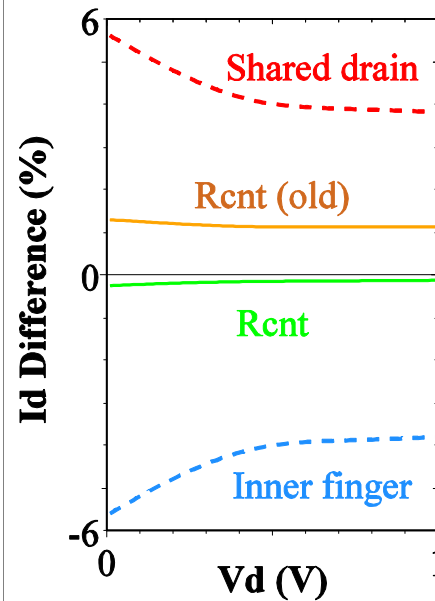


$N_f = 3$

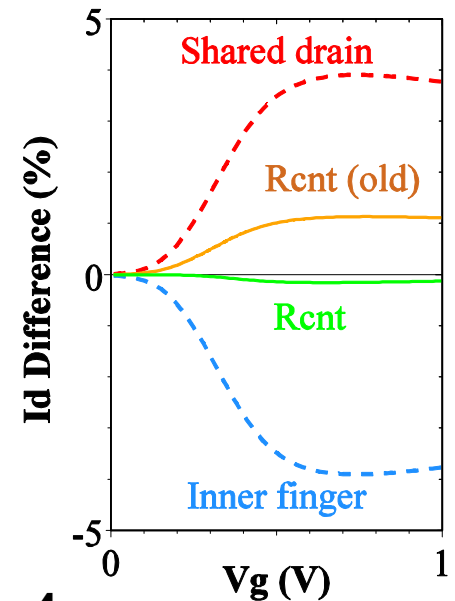
$V_g = V_{dd} = 0.9 \text{ V}$

Base Id: Full netlist, I_{tot} / N_f

Only contact R is included



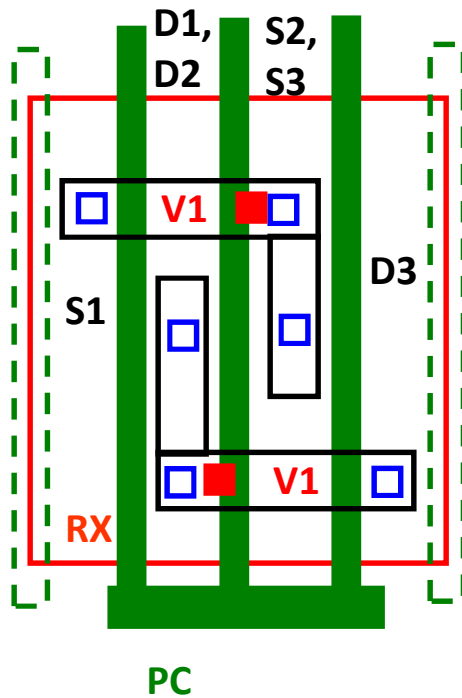
$N_f = 4$



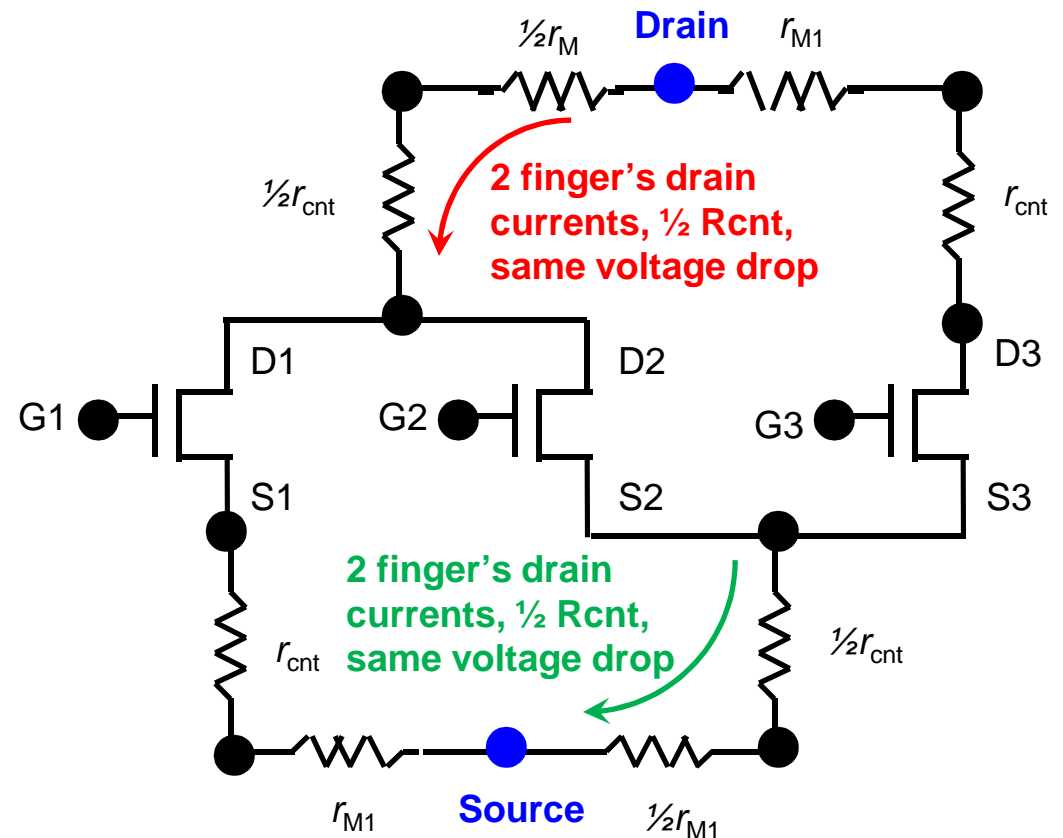
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Full Utilization of Available Breakdown Voltage



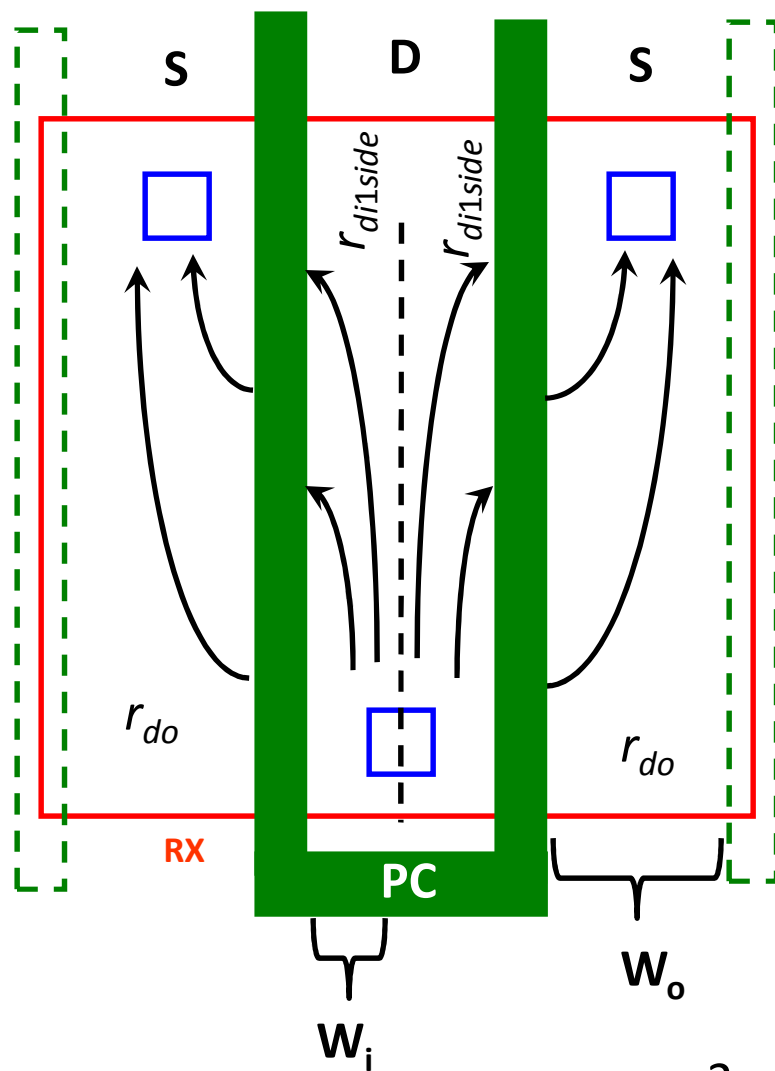
Contact number in an inner diffusion region: contact number in an outer diffusion region = 2 : 1.



Ignored diffusion R in the above netlist

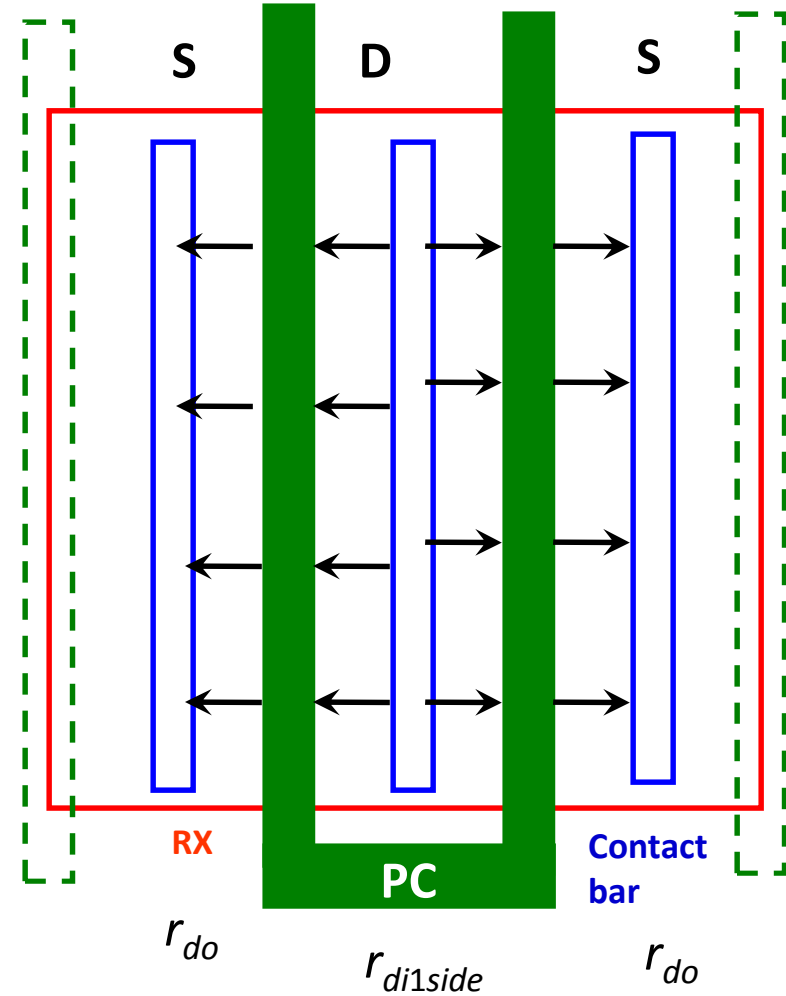
No more symmetry breaking?

Silicide Diffusion Resistance



$$W_i = \frac{1}{2}W_o$$

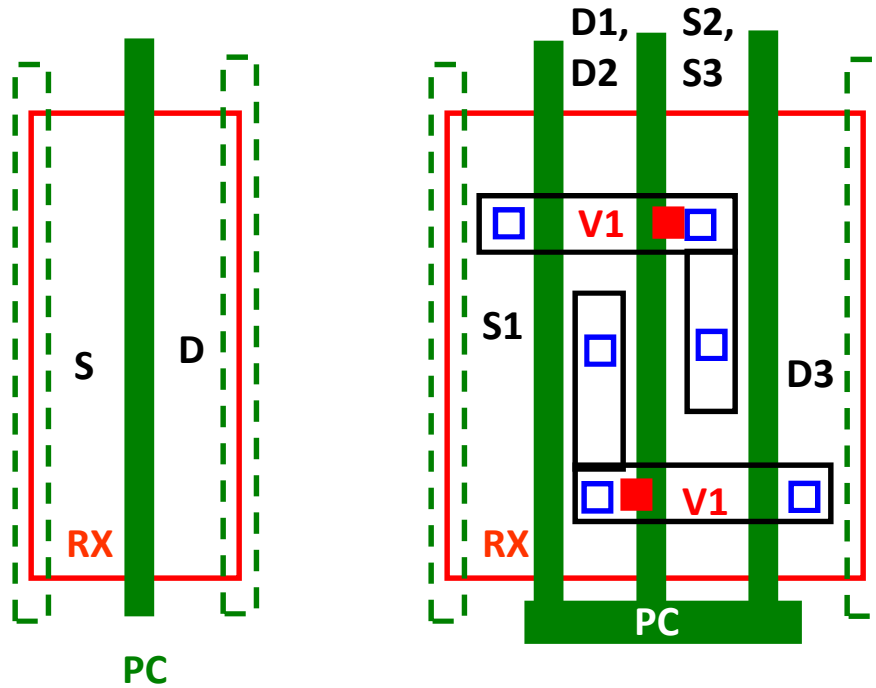
$$r_{di1side} \approx 2r_{do}$$



$$r_{di1side} \approx r_{do}$$

In general, $1 \leq r_{di1side} / r_{do} \leq 2$

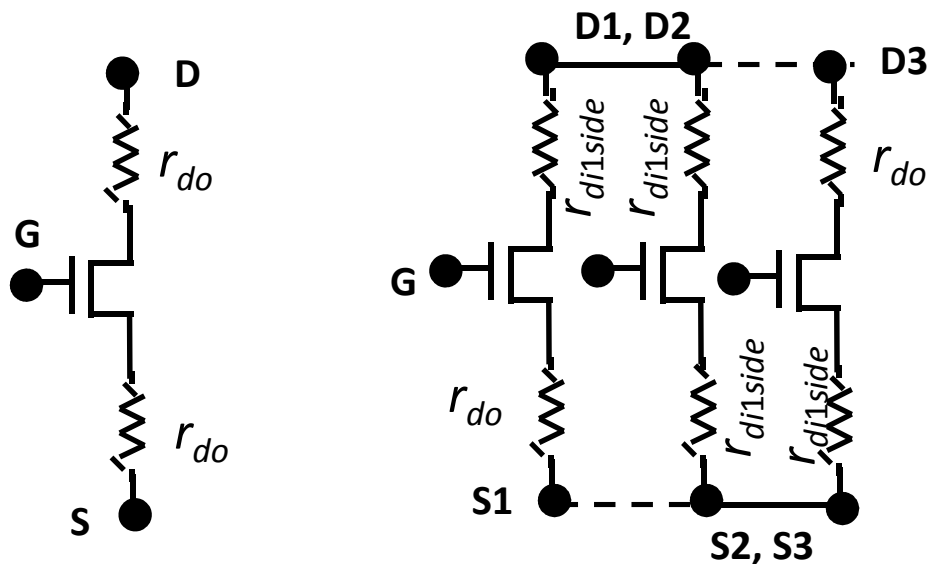
Symmetry Breaking Due to Diffusion Resistance



Since $r_{di1side} > r_{do}$,

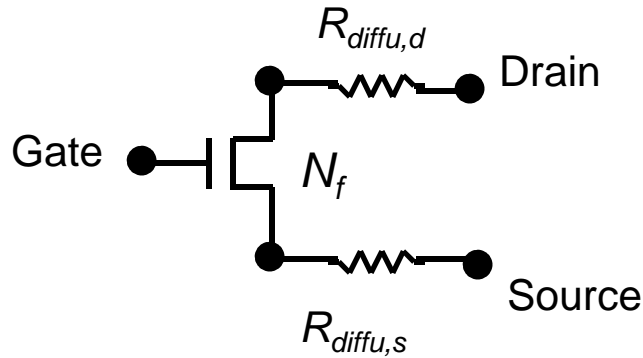
$$i_{d,inner} < i_{d,outer} < i_{d,singleFinger}$$

(due to silicide diffusion resistance only)



Symmetry is broken

Effective Source/Drain Diffusion Resistance



For efficient SPICE simulations, we want to use a single FET instance to represent a multi-finger FET
 → Need effective source and drain diffusion R

Approximation: The drain current passing through each finger channel is the same.

$$R_{diffu,s} = R_{diffu,d} = \frac{r_{do} + (N_f - 1)r_{di1side}}{N_f^2}, \quad \text{odd } N_f;$$

$$R_{diffu,s} = \frac{2r_{do} + (N_f - 2)r_{di1side}}{N_f^2}, \quad R_{diffu,d} = \frac{r_{di1side}}{N_f}, \quad \text{even } N_f.$$

Limit 1: When $r_{di1side} = r_{do}$, $R_{diffu,s} = R_{diffu,d} = \frac{r_{do}}{N_f}$, both even and odd N_f .

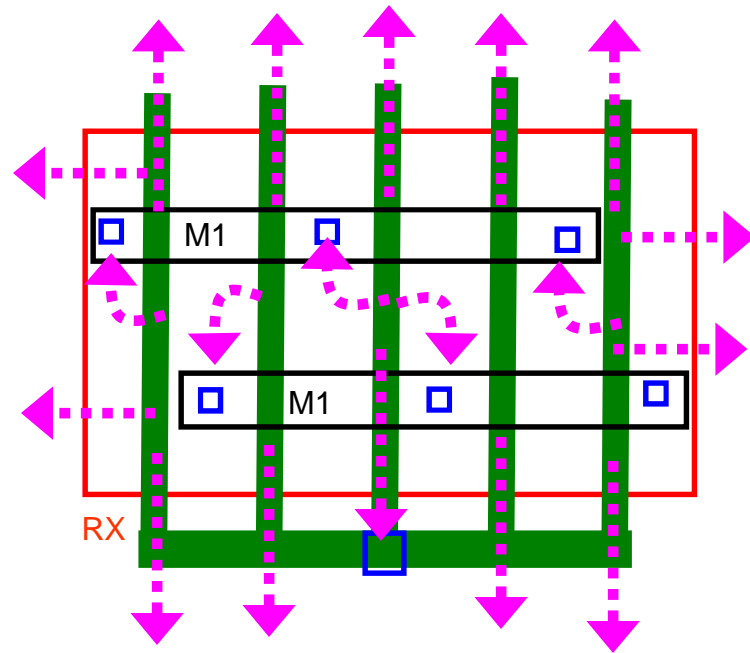
Limit 2: When $r_{di1side} = 2r_{do}$,

$R_{diffu,s}$ and $R_{diffu,d}$ reduce to the form of previous contact R expressions.

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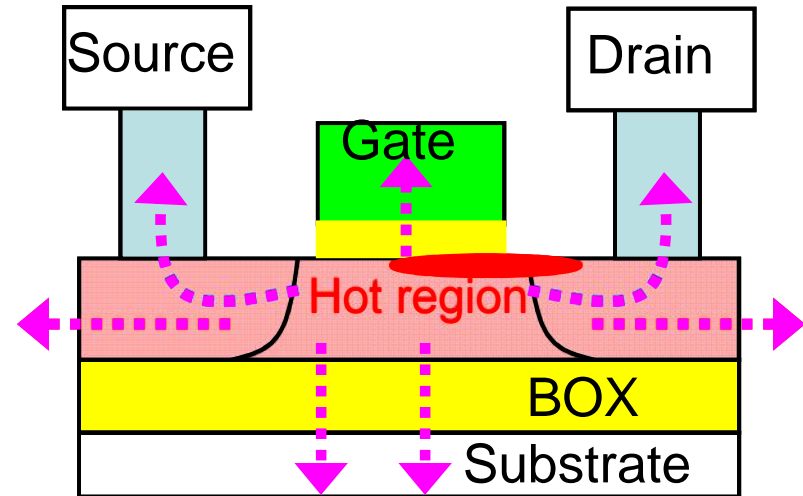
Self Heating in FETs



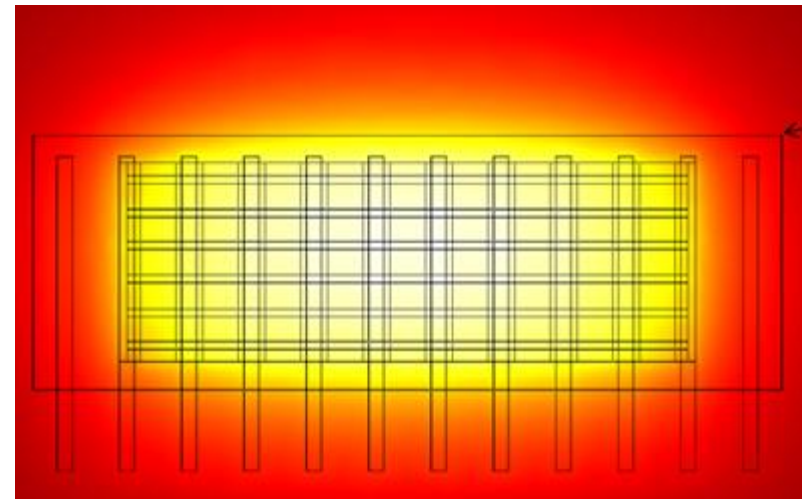
$$\Delta T = R_{th} \text{ Power}$$

Thermal resistance
$$R_{th} = \frac{1}{G_{th,A}A + G_{th,P}P}$$

Ignored the difference between
outer and inner finger channels



Energy dissipated near the drain is
conducted away through
BOX/substrate, contacts and gate

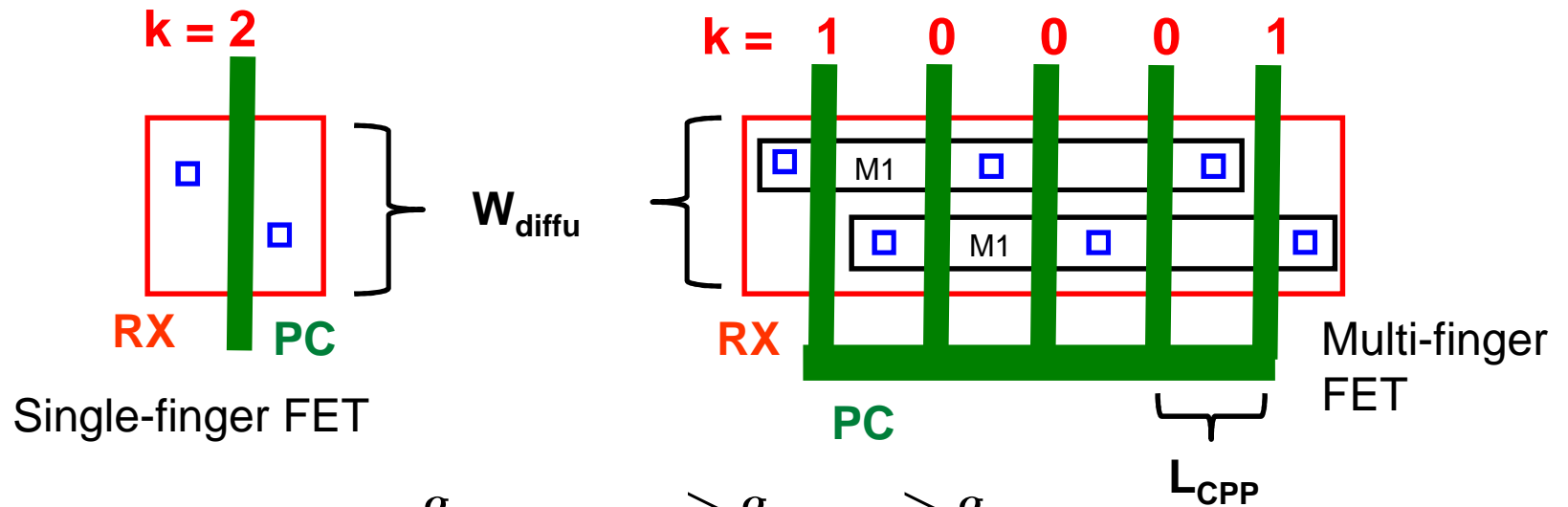


14nm FinFET, C. Scott, IBM Research

An Improved Self-Heating Characterization

Inner- and outer-finger channels in a multi-finger FET and a single-finger channel have different ΔT values due to self heating

$$g_{th,n} \equiv \frac{1}{r_{th,n}} = G_{th,A} L_{CPP} W_{diffu} + G_{th,P} (2L_{CPP} + kW_{diffu}), \quad \sum_{n=1}^{N_f} g_{th,n} = \frac{1}{R_{th}}$$



$$g_{th, \text{singleFinger}} > g_{th, \text{outer}} > g_{th, \text{inner}}$$

$$r_{th, \text{singleFinger}} < r_{th, \text{outer}} < r_{th, \text{inner}}$$

$$i_{d, she, \text{singleFinger}} > i_{d, she, \text{outer}} > i_{d, she, \text{inner}}$$

Symmetry is broken

Effect of self heating
on drain current:

$$i_{d, she} = \frac{i_d}{1 + y_{r_{th}} i_d v_{ds}},$$

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Sub-threshold Drain Current

Ignore the effects of wire R, contact R, diffusion R, self heating, stress, etc.

Consider uncorrelated random variations among different fingers of a multi-finger FET. Focus on sub-threshold drain current and V_t variations.

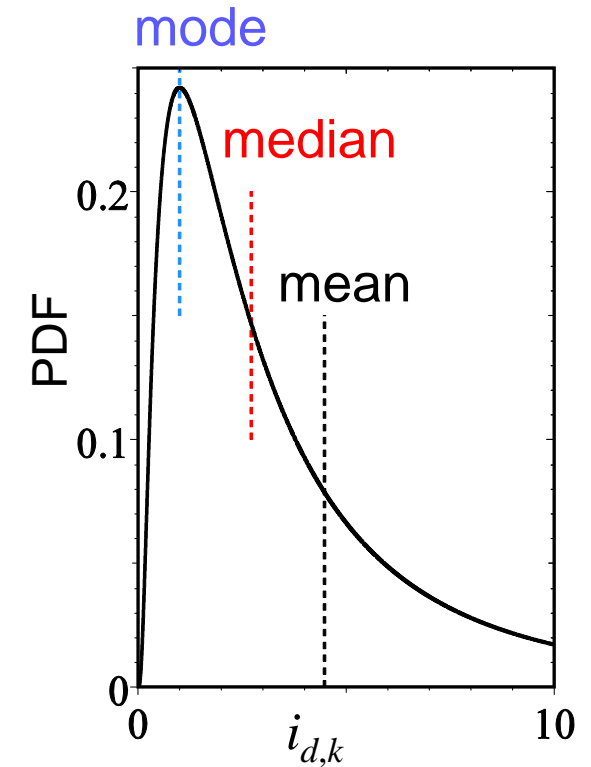
Distribution of sub-threshold drain current in each finger: A log-normal distribution;

$$i_{d,k} \propto \exp\left(\frac{V_{gs} - v_{t,k}}{nv_t}\right)$$

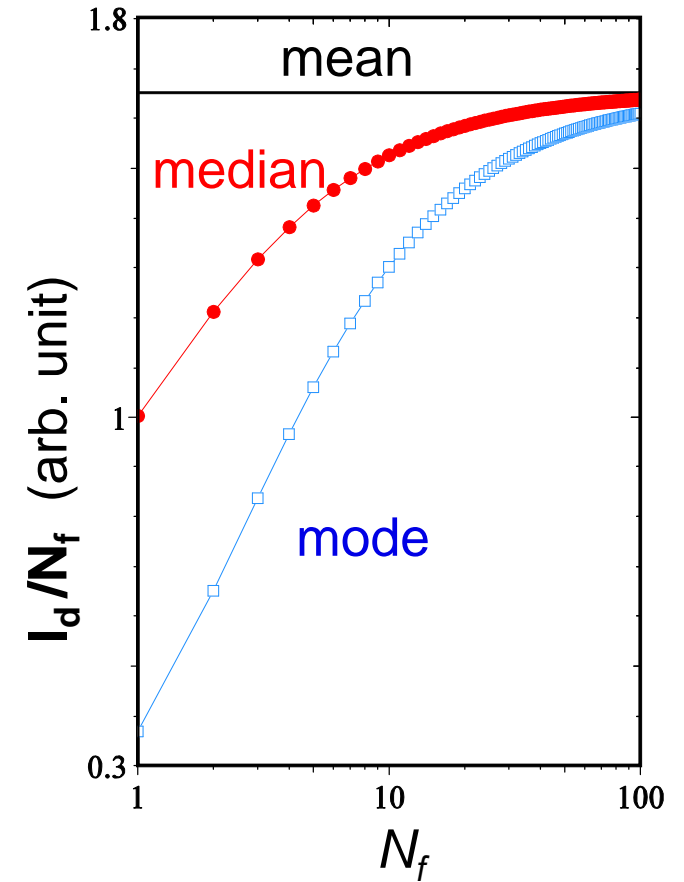
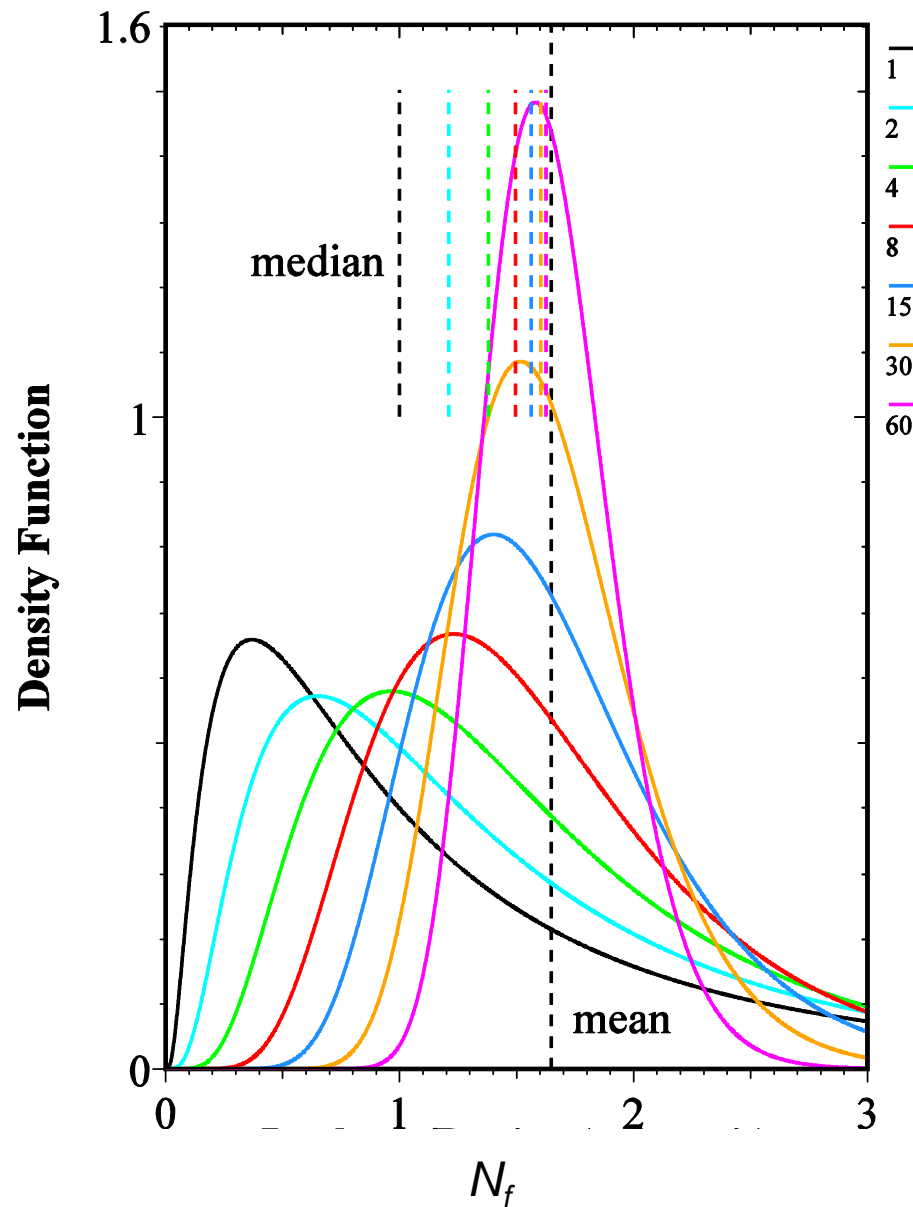
Total sub-threshold drain current:
A sum of N_f partially correlated log-normal distributions.

$$I_d = \sum_{k=1}^{N_f} i_{d,k}$$

Symmetry is kept
in mean drain current: $\frac{\langle I_d \rangle}{N_f} = i_d(\text{mean})$



Symmetry Breaking Due to Uncorrelated Variations



$$\frac{I_d(\text{median})}{N_f} > i_d(\text{median}), \quad N_f \geq 2$$

**Symmetry is broken
in median drain current.**

Summary

- Showed that there is a symmetry breaking in the drain current of multi-finger FETs
 - Cause: From exterior to interior, each of wire R, contact R, diffusion R, self heating, uncorrelated random variations alone
 - Effect: The drain current in one or more fingers to be different from that in other fingers, or
 - Effect: The per-finger drain current is different from the drain current of a corresponding single-finger FET
- Presented analytic expressions for effective contact and diffusion resistances that can be used with a single instance of FET model to represent a whole multi-finger FET
- Presented an improved self-heating characterization and modeling approach